

Title (en)

SEMI AROMATIC POLYAMIDE RESIN COMPOSITIONS, PROCESSES FOR THEIR MANFACTURE AND ARTICLES THEREOF

Title (de)

HALBAROMATISCHE POLYAMIDHARZZUSAMMENSETZUNGEN, VERFAHREN ZU IHRER HERSTELLUNG UND ARTIKEL DARAUS

Title (fr)

COMPOSITIONS DE RÉSINE DE POLYAMIDE SEMI-AROMATIQUE, PROCÉDÉS DE FABRICATION ET ARTICLES ASSOCIÉS

Publication

**EP 2454322 A1 20120523 (EN)**

Application

**EP 10736933 A 20100719**

Priority

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- US 22634609 P 20090717

Abstract (en)

[origin: WO2011009111A1] The present invention relates to a high temperature polyamide resin composition for moulded articles, articles formed therefrom and processes for producing the composition, comprising: semi-aromatic polyamide with a melt temperature above 280C and one or more oxidized polyethylene lubricants as internal lubricant.

IPC 8 full level

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CPC (source: EP KR US)

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C-Set (source: EP US)

1. **C08L 77/06 + C08L 91/06**
2. **C08L 77/06 + C08L 2666/06**

Citation (search report)

See references of WO 2011009111A1

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